

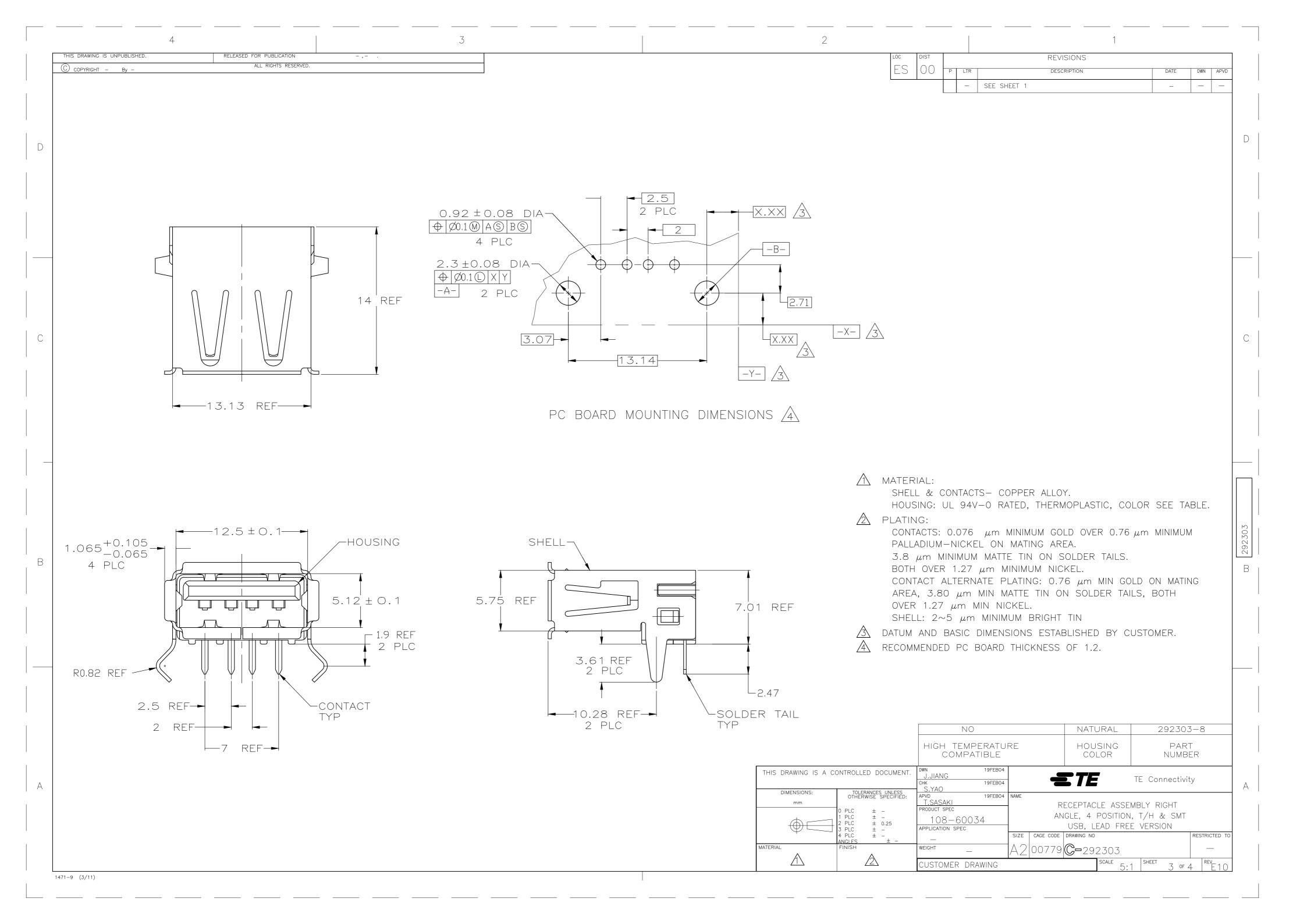
		LOC DIST	—	REVISIONS]	
		ES 00	P LTR	DESCRIPTION	DATE	DWN	APVD		
			-	SEE SHEET 1	_		_	_	
0									
	\wedge							D	
<u> </u>	$\overline{\langle + \rangle}$	MATERIAL:		S- COPPER ALLOY.					
Y				-0 RATED, THERMOPLASTIC, COL	OR SEE	TABI	LE.		
A	2	PLATING:							
1 3.50	<u>د ــــــــــــــــــــــــــــــــــــ</u>	CONTACTS: 0.076 μ m MINIMUM GOLD OVER 0.76 μ m MINIMUM							
¥		PALLADIUM-	NICKEL	ON MATING AREA.					
Ī				MATTE TIN ON SOLDER TAILS.					
1.00		BOTH OVER 1.27 μ m MINIMUM NICKEL.							
		CONTACT ALTERNATE PLATING: 0.76 μ m MIN GOLD ON MATING AREA, 3.80 μ m MIN MATTE TIN ON SOLDER TAILS, BOTH							
		OVER 1.27			$\cup, \cup \cup \cdots$				
_				MINIMUM BRIGHT TIN					
		RECOMMENDED	PC B	DARD THICKNESS OF 1.42.					
	<u> </u>								
	•								
MOUNTING LAYOUT	$\overline{3}$								

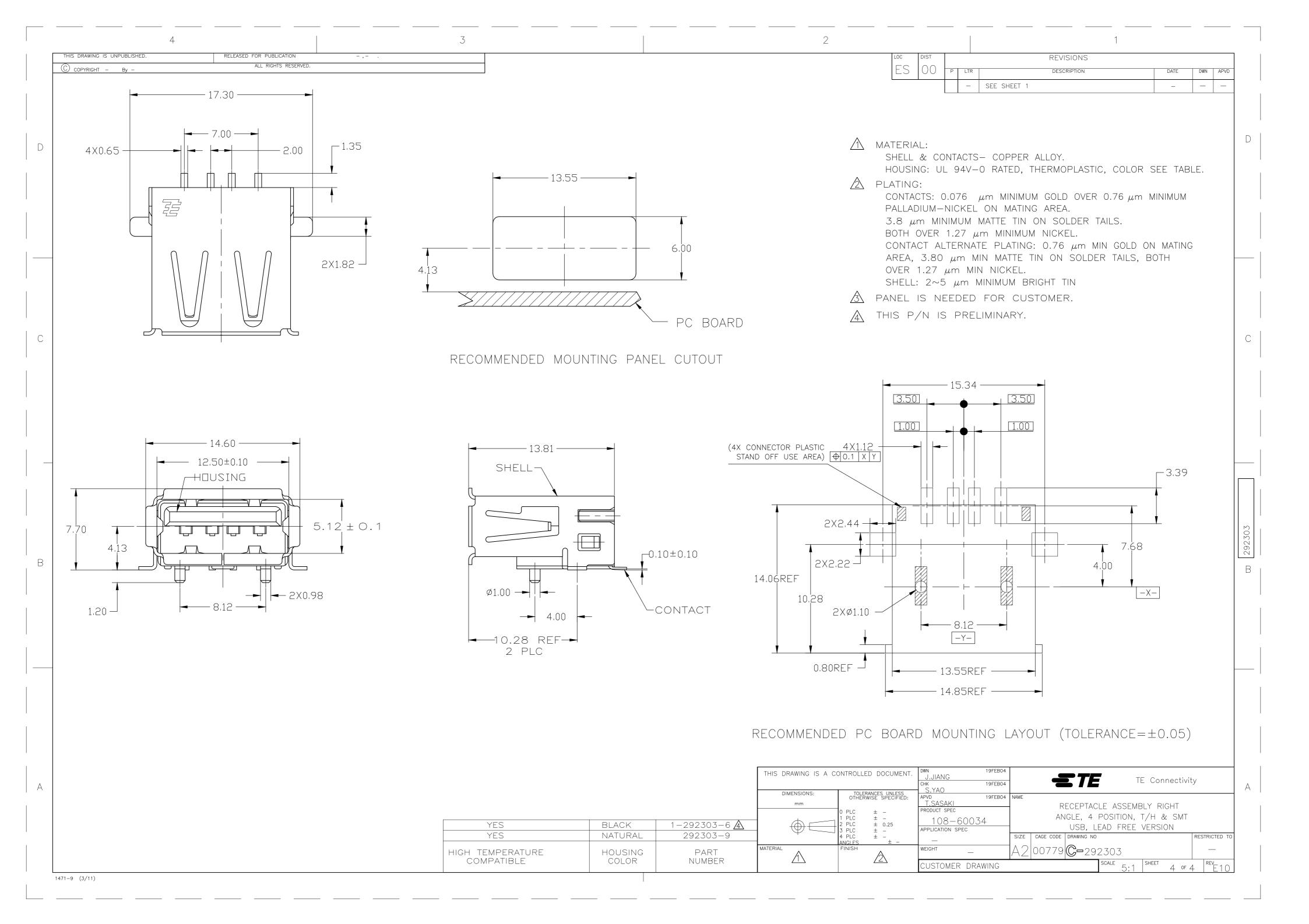
	YES	BLACK	3-292303-1€10		
	YES	BLACK	ACK 1-292303-1		
	YES	NATURAL	292303-7		
	HIGH TEMPERATURE COMPATIBLE	HOUSING COLOR	PART NUMBER		
THIS DRAWING IS A CONTROLLED DOCUMENT.	DWN 19FEB04 J.JIANG CHK 19FEB04 S.YAO	TE Connectivity			
DIMENSIONS: mm 0 PLC ± - 1 PLC ± - 2 PLC ± 0.25 3 PLC ± -	APVD 19FEB04 NAME T.SASAKI RECEPTACLE ASSEMBLY RIGHT PRODUCT SPEC ANGLE, 4 POSITION, T/H & SMT 108-60034 USB, LEAD FREE VERSION				
A PLC ± - ANGLES ± - MATERIAL FINISH		DRAWING NO	RESTRICTED TO		
	CUSTOMER DRAWING	SCALE 5:	1 SHEET 2 OF 4 E10		

292303

В

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TE Connectivity: 292303-9